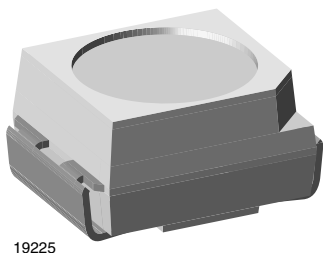


## UV SMD LED PLCC-2



19225

### DESCRIPTION

The package of the VLMU3100 series is the PLCC-2. It consists of a lead frame which is embedded in a white thermoplast. The reflector inside this package is filled up with clear silicone which guarantees long life time. The viewing angle is 120°, package dimensions are 3.2 mm x 2.8 mm x 1.9 mm.

### PRODUCT GROUP AND PACKAGE DATA

- Product group: LED
- Package: SMD PLCC-2
- Product series: standard
- Angle of half intensity:  $\pm 60^\circ$
- Lead-finishing: Ag

### FEATURES

- UV SMD LED with exceptional brightness
- High efficient InGaN technology
- Long life time due to silicone casting
- Compatible with automatic placement equipment
- EIA and ICE standard package
- Compatible with IR reflow and vapor phase
- Available in 8 mm tape
- Low profile package
- Non-diffused lens: excellent for coupling to light pipes and backlighting
- Low power consumption
- Preconditioning according to JEDEC® level 2a
- ESD-withstand voltage: up to 1 kV according to JESD22-A114-B
- Material categorization: for definitions of compliance please see [www.vishay.com/doc?99912](http://www.vishay.com/doc?99912)



**RoHS**  
COMPLIANT  
HALOGEN  
**FREE**  
**GREEN**  
(5-2008)

### APPLICATIONS

- Curing of glue and laquer
- Recognition of safety features of money bills

### SAFETY ADVICES

Depending on the mode of operation, these devices emit highly concentrated non visible ultraviolet light which can be hazardous to the human eye. Products which incorporate these devices have to follow the safety precautions given in IEC 60825-1 "Safety of Laser Products".

### PARTS TABLE

PART	COLOR	RADIANT INTENSITY (mW/sr)			at I <sub>F</sub> (mA)	WAVELENGTH (nm)			at I <sub>F</sub> (mA)	FORWARD VOLTAGE (V)			at I <sub>F</sub> (mA)	TECHNOLOGY
		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		MIN.	TYP.	MAX.		
VLMU3100-GS08	Ultraviolet	1.8	2.5	3	20	400	405	410	20	2.8	3.2	3.8	20	InGaN

### ABSOLUTE MAXIMUM RATINGS (T<sub>amb</sub> = 25 °C, unless otherwise specified)

PARAMETER	TEST CONDITION	SYMBOL	VALUE	UNIT
Forward current		I <sub>F</sub>	30	mA
Surge forward current	t <sub>p</sub> ≤ 10 μs	I <sub>FSM</sub>	0.1	A
Power dissipation		P <sub>tot</sub>	120	mW
Junction temperature		T <sub>j</sub>	+100	°C
Operating temperature range		T <sub>amb</sub>	-40 to +80	°C
Storage temperature range		T <sub>stg</sub>	-40 to +100	°C
Solder temperature		T <sub>sol</sub>	260/5	°C/s

**OPTICAL AND ELECTRICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)  
**VLMU3100, ULTRAVIOLET**

PARAMETER	TEST CONDITION	SYMBOL	MIN.	TYP.	MAX.	UNIT
Radiant intensity	$I_F = 20\text{ mA}$	$I_e$	1.8	2.5	3	mW/sr
Radiant power	$I_F = 20\text{ mA}$	$\phi_e$	-	6.8	-	mW
Peak wavelength	$I_F = 20\text{ mA}$	$\lambda_p$	400	405	410	nm
Angle of half intensity	$I_F = 20\text{ mA}$	$\varphi$	-	$\pm 60$	-	deg
Forward voltage	$I_F = 20\text{ mA}$	$V_F$	2.8	3.2	3.8	V
Reverse current	$V_R = 5\text{ V}$	$I_R$	-	-	10	$\mu\text{A}$

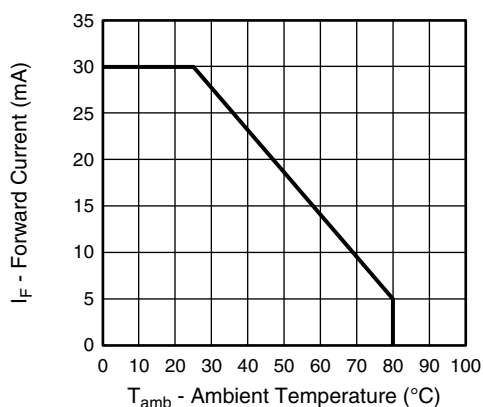
**TYPICAL CHARACTERISTICS** ( $T_{amb} = 25^{\circ}\text{C}$ , unless otherwise specified)


Fig. 1 - Forward Current vs. Ambient Temperature

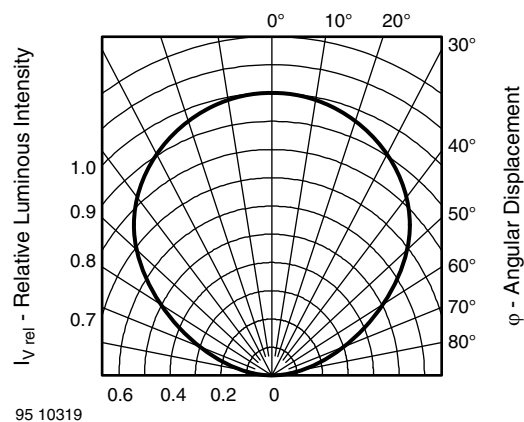


Fig. 3 - Relative Luminous Intensity vs. Angular Displacement

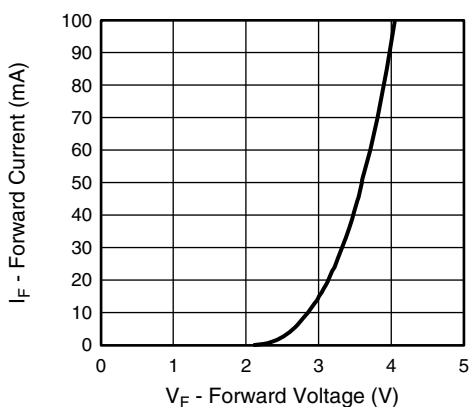


Fig. 2 - Forward Current vs. Forward Voltage

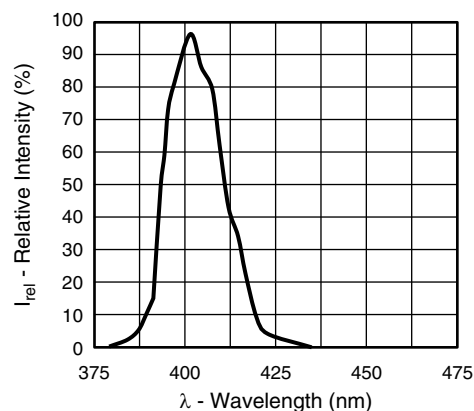


Fig. 4 - Relative Intensity vs. Wavelength

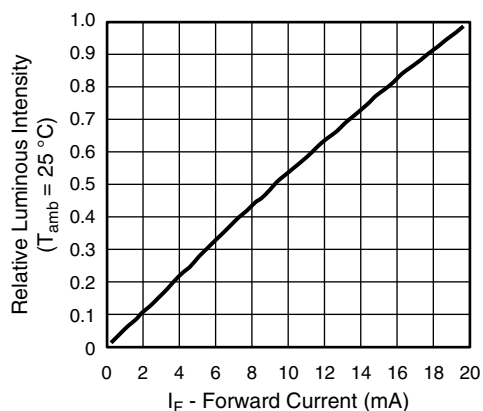


Fig. 5 - Specific Luminous Intensity vs. Forward Current

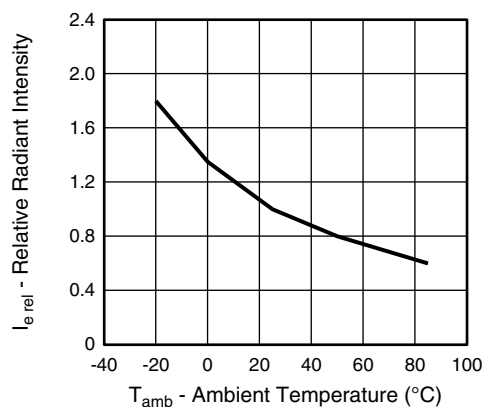
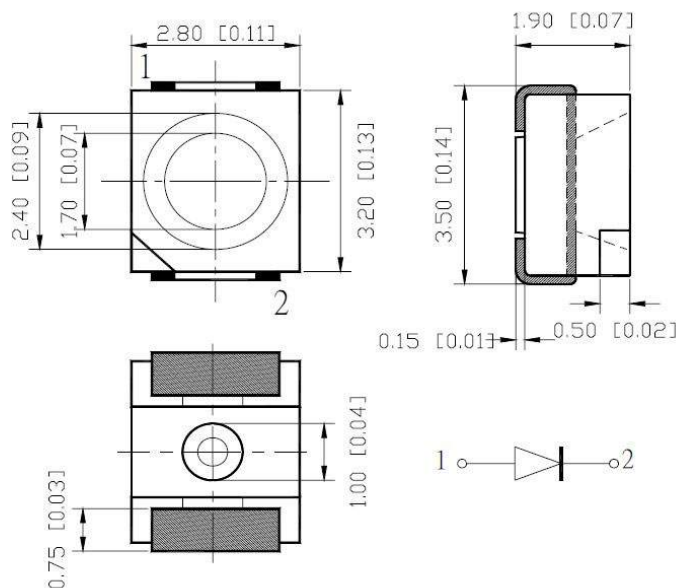
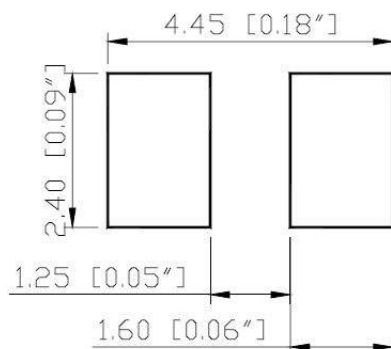


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

### PACKAGE DIMENSIONS in millimeters



### SOLDER PAD LAYOUT



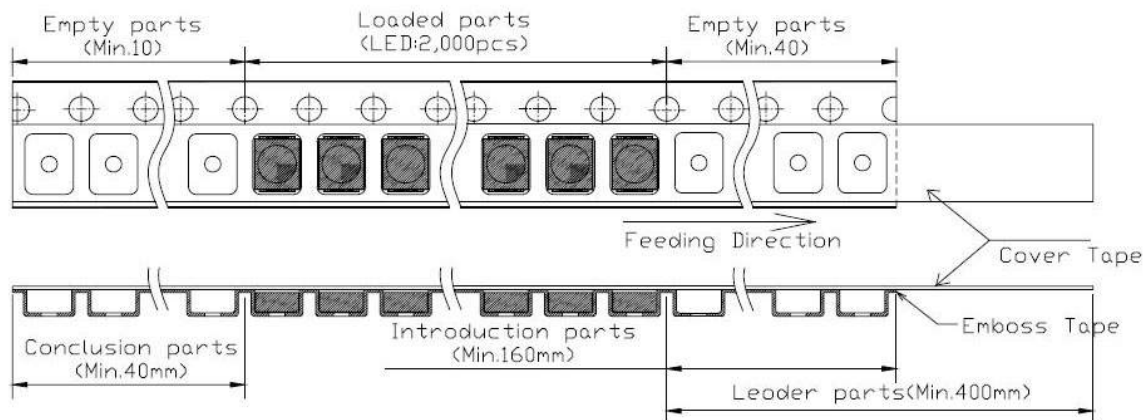
## METHOD OF TAPING/POLARITY AND TAPE AND REEL

### SMD LED (VLM3 - SERIES)

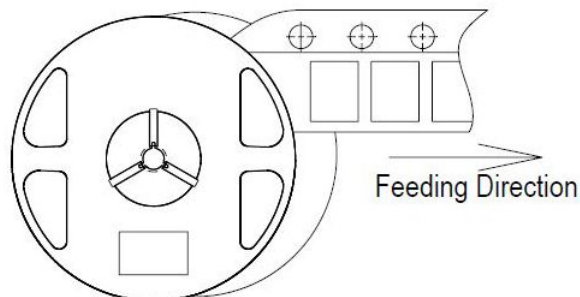
Vishay's LEDs in SMD packages are available in an antistatic 8 mm blister tape (in accordance with DIN IEC 40 (CO 564) for automatic component insertation. The blister

tape is a plastic strip with impressed component cavities, covered by a top tape.

### ARRANGEMENT OF TAPE

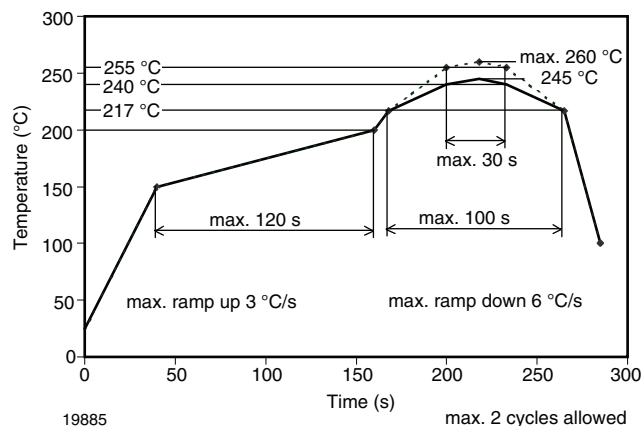


### FEEDING DIRECTION



### SOLDERING PROFILE

IR Reflow Soldering Profile for Lead (Pb)-Free Soldering  
Preconditioning according to JEDEC level 2a



### DIMENSIONS OF REEL in millimeters

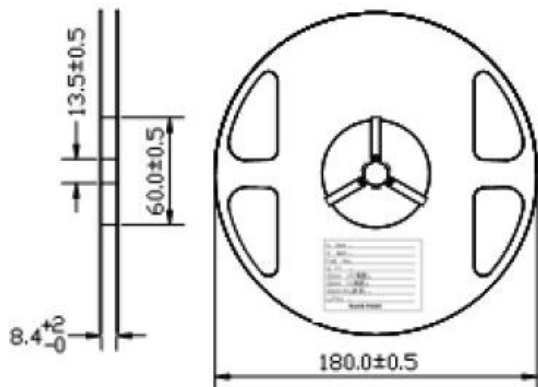


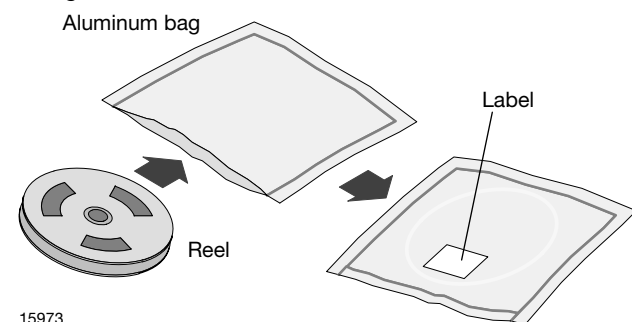
Fig. 7 - Vishay Lead (Pb)-Free Reflow Soldering Profile  
(according to J-STD-020C)

**BAR CODE PRODUCT LABEL** (example only)


- A. 2D barcode
- B. Vishay part number
- C. Quantity
- D. SEL = selection code (binning)
- E. Code of manufacturing plant
- F. Batch = date code: year / week / plant code
- G. Region code
- H. SL = sales location
- I. Terminations finishing
- K. Lead (Pb)-free symbol
- L. Halogen-free symbol
- M. RoHS symbol

**DRY PACKING**

The reel is packed in an anti-humidity bag to protect the devices from absorbing moisture during transportation and storage.



15973

**FINAL PACKING**

The sealed reel is packed into a cardboard box. A secondary cardboard box is used for shipping purposes.

**RECOMMENDED METHOD OF STORAGE**

Dry box storage is recommended as soon as the aluminum bag has been opened to prevent moisture absorption. The following conditions should be observed, if dry boxes are not available:

- Storage temperature 10 °C to 30 °C
- Storage humidity ≤ 60 % RH max.

After more than 672 h under these conditions moisture content will be too high for reflow soldering.

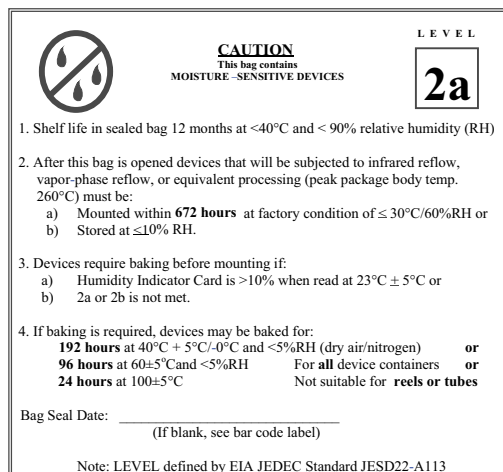
In case of moisture absorption, the devices will recover to the former condition by drying under the following condition:

192 h at 40 °C + 5 °C / - 0 °C and < 5 % RH (dry air / nitrogen) or

96 h at 60 °C + 5 °C and < 5 % RH for all device containers or

24 h at 100 °C + 5 °C not suitable for reel or tubes.

An EIA JEDEC standard JESD22-A112 level 2a label is included on all dry bags.



Example of JESD22-A112 level 2a label

**ESD PRECAUTION**

Proper storage and handling procedures should be followed to prevent ESD damage to the devices especially when they are removed from the antistatic shielding bag. Electro-static sensitive devices warning labels are on the packaging.

**VISHAY SEMICONDUCTORS STANDARD BAR CODE LABELS**

The Vishay Semiconductors standard bar code labels are printed at final packing areas. The labels are on each packing unit and contain Vishay Semiconductors specific data.



## Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.